



Click [here](#) for the 3D model.

General Information

| | |
|-------------------------|---|
| Series | KPS LDD Mil SMPS PRF49470 |
| Style | Leaded Stacked Chip |
| Description | Low ESR, High Current Stacked Ceramic Chips |
| Features | Low ESR, High Current |
| RoHS | No |
| Prop 65 | WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov/ |
| Termination | 60/40 Solder Coated |
| Lead | J Leads |
| Failure Rate | N/A |
| Testing and Reliability | Level B |
| Qualifications | MIL-PRF-49470 |
| Notes | Note: Number of chips in stack depends on design. Note: Turn Radius For Lead Extension Is 0.1 Radians (Typical). Note: Lead alignment within pin rows shall be within ±0.13 mm. |

| Dimensions | |
|------------|--------------------|
| D | 6.335mm +/-0.645mm |
| L | 1.78mm +/-0.25mm |
| T | 1.397mm MAX |
| S | 2.54mm TYP |
| F | 0.254mm +/-0.051mm |
| A | 12.192mm MAX |
| C | 6.35mm +/-0.635mm |
| E | 7.62mm MAX |
| LO | 1.586mm MAX |
| LW | 0.508mm +/-0.051mm |
| MP | 1.27mm MIN |

| Specifications | |
|---------------------------------|--------------|
| Capacitance | 2.7 uF |
| Tolerance | 10% |
| Voltage DC | 100 VDC |
| Dielectric Withstanding Voltage | 250 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | BX |
| Dissipation Factor | 2.5% |
| Insulation Resistance | 370.37 MOhms |

| Packaging Specifications | |
|--------------------------|-------------|
| Packaging | Waffle, Box |
| Packaging Quantity | 64 |

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